

THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: : Naoyoshi KIMURA, et al.
Filed: : Concurrently herewith
For: : MOLD DEVICE FOR INJECTION
Serial No. : Concurrently herewith

December 28, 2001

Assistant Commissioner of Patents
Washington, D.C. 20231

PRELIMINARY AMENDMENT

S I R:

Prior to the issuance of an Office Action, please amend the specification and claims as follows:

IN THE CLAIMS:

Please amend the following claims:

5.(Amended) The mold device for injection molding of synthetic resin according to claim 3, wherein said mold base and said slide cavity block are provided with heating and cooling channels for permitting heating medium and cooling medium to alternately and repeatedly flow therein.

Please add the following new claim:

6.(New) The mold device for injection molding of synthetic resin according to claim 4, wherein said mold base and said slide cavity block are provided with heating and cooling channels for permitting heating medium and cooling medium to alternately and repeatedly flow therein.

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